

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1067MHz capability for CPU at 2.66, 2.8 and 2.93GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Label(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
CORSAIR	CM3X1024-1066C7	1024MB	DS	N/A	Heat-Sink Package	7	1.1	.	.	.
Crucial	CT12864BA1067.8FF	1024MB	SS	MICRON	D9KPT	7(1066-7-7-7-20)		.	.	.
Crucial	CT12864BA1067.8SFD	1024MB	SS	MICRON	D9JNL	7		.	.	.
Crucial	CT12872BA1067.9FF	1024MB	SS	MICRON	D9KPT(ECC)	7(1066-9-9-9-25)		.	.	.
Crucial	CT25664BA1067.16FF	2048MB	DS	MICRON	D9KPT	7(1066-7-7-7-20)		.	.	.
Crucial	CT25664BA1067.16SFD	2048MB	DS	MICRON	D9JNL	7		.	.	.
Crucial	CT25672BA1067.18FF	2048MB	DS	MICRON	D9KPT(ECC)	7(1066-7-7-7-20)		.	.	.
ELPIDA	EBJ10UE8BAW0-AE-E	1024MB	SS	ELPIDA	J1108BABG-DJ-E	7(1066-7-7-7-20)		.	.	.
ELPIDA	EBJ11RD8BAFA-AE-E	1024MB	DS	ELPIDA	J5308BASE-AC-E(ECC)	7		.	.	.
ELPIDA	EBJ11UD8BAFA-AG-E	1024MB	DS	ELPIDA	J5308BASE-AC-E	8		.	.	.
ELPIDA	EBJ21UE8BAW0-AE-E	2048MB	DS	ELPIDA	J1108BABG-DJ-E	7(1066-7-7-7-20)		.	.	.
Hynix	HMT112U6AFP8C-G7N0	1024MB	SS	HYNIX	H5TQ1G83AFP6G7C	7		.	.	.
Hynix	HYMT112U64ZNF8-G7	1024MB	SS	HYNIX	HY5TQ1G831ZNF6-G7	7		.	.	.
Hynix	HMT125U6AFP8C-G7N0	2048MB	DS	HYNIX	H5TQ1G83AFP6G7C	7		.	.	.
Hynix	HYMT125U64ZNF8-G7	2048MB	DS	HYNIX	HY5TQ1G831ZNF6-G7	7		.	.	.
KINGSTON	KVR1066D3N7/1G	1024MB	SS	ELPIDA	J1108BABG-DJ-E	1066-7-7-7-20	1.5	.	.	.
KINGSTON	KVR1066D3N7/2G	2048MB	DS	ELPIDA	J1108BABG-DJ-E	1066-7-7-7-20	1.5	.	.	.
KINGSTON	KVR1066D3N7/4G	4096MB	DS	SAMSUNG	K4B2G0846B-HCF8	1066-7-7-7-20	1.5	.	.	.
MICRON	MT8JTF12864AY-1G1D1	1024MB	SS	MICRON	7VD22	7		.	.	.
MICRON	MT8JTF12864AZ-1G1F1	1024MB	SS	MICRON	8ZF22 D9KPV	7(1066-7-7-7-20)		.	.	.
MICRON	MT8JTF12864AZ-1G1F1	1024MB	SS	MICRON	D9KPT	7(1066-7-7-7-20)		.	.	.
MICRON	MT9JSF12872AZ-1G1F1	1024MB	SS	MICRON	D9KPT(ECC)	7(1066-9-9-9-25)		.	.	.
MICRON	MT16JTF25664AY-1G1D1	2048MB	DS	MICRON	7VD22	7		.	.	.
MICRON	MT16JTF25664AZ-1G1F1	2048MB	DS	MICRON	8ZF22 D9KPV	7(1066-7-7-7-20)		.	.	.
MICRON	MT16JTF25664AZ-1G1F1	2048MB	DS	MICRON	D9KPT	7(1066-7-7-7-20)		.	.	.
MICRON	MT18JSF25672AZ-1G1F1	2048MB	DS	MICRON	D9KPT(ECC)	7(1066-7-7-7-20)		.	.	.
SAMSUNG	M378B5273BH1-CF8	4096MB	DS	SAMSUNG	K4B2G0846B-HCF8	8(7-7-7-20)	1.5	.	.	.
Transcend	TS256MLK84V1U	2048MB	DS	ELPIDA	J1108BABG-AE-E	7(1066-7-7-7-20)		.	.	.
Asint	SLY3128M8-EAE	1024MB	SS	Asint	DDRIII1208-AE	(7-7-7-20)		.	.	.
Asint	SLZ3128M8-EAE	2048MB	DS	Asint	DDRIII1208-AE	(7-7-7-20)		.	.	.
WINTEC	3DU3191A-10	1024MB	DS	Gilmonda	IDSH51-03A1F1C-10F	7		.	.	.

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1333MHz capability for CPU at 2.66, 2.8 and 2.93GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
A-DATA	AD133301GOU	1024MB	SS	A-DATA	AD30908C8D-15IG	1333-9-9-9-24		.	.	.
A-DATA	AD1333002GOU	2048MB	DS	A-DATA	AD30908C8D-15IG	1333-9-9-9-24		.	.	.
A-DATA	AD31333E002G0U	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)	1.65-1.85	.	.	.
Apacer	78.01GC8.420	1024MB	SS	ELPIDA	J1108BABG-DJ-E	(1333-9-9-9-24)		.	.	.
Apacer	78.01GC8.9L0	1024MB	SS	Apacer	AM5D5808AEWSBG	9(1333-9-9-9-24)		.	.	.
Apacer	78.01GC8.422	1024MB	SS	ELPIDA	J1108BABG-DJ-E(ECC)	(1333-9-9-9-24)		.	.	.
Apacer	78.A1GC8.421	2048MB	DS	ELPIDA	J1108BABG-DJ-E	(1333-9-9-9-24)		.	.	.
Apacer	78.A1GC8.9L1	2048MB	DS	Apacer	AM5D5808AEWSBG	9(1333-9-9-9-24)		.	.	.
Apacer	78.A1GC8.423	2048MB	DS	ELPIDA	J1108BABG-DJ-E(ECC)	(1333-9-9-9-24)		.	.	.
CORSAIR	TR3X3G1333C9 (Ver.2.1)	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.5	.	.	.
CORSAIR	CM3X1024-1333C9DHX	1024MB	DS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.1	.	.	.
CORSAIR	BoxP/N:TWIN3X2048-1333C9 (CM3X1024-1333C9)Ver1.1	2048MB(Kit of 2)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.70	.	.	.
CORSAIR	BoxP/N:TW3X4G1333C9DHX (CM3X2048-1333C9DHX)Ver3.2	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.70	.	.	.
CORSAIR	TR3X6G1333C9 (Ver.2.1)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.5	.	.	.
Crucial	CT12864BA1339.8FF	1024MB	SS	MICRON	D9KPT	9(1333-9-9-9-24)		.	.	.
Crucial	CT12864BA1339.8SFD	1024MB	SS	MICRON	MT8JF12864AY-1G4D1	(1333-9-9-9-24)		.	.	.
Crucial	CT12872BA1339.9FF	1024MB	SS	MICRON	D9KPT(ECC)	9(1333-9-9-9-24)		.	.	.
Crucial	CT25664BA1339.16FF	2048MB	DS	MICRON	D9KPT	9(1333-9-9-9-24)		.	.	.

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1333MHz capability for CPU at 2.66, 2.8 and 2.93GHz (continued)

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm/Bios	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
Crucial	CT25672BA1339.18FF	2048MB	DS	MICRON	D9KPT(ECC)	9(1333-9-9-9-24)		*	*	*
Crucial	BL25664BA1336.16SFB1	4096MB(Kit of 2)	DS	NA	Heat-Sink Package	6-6-6-20(1333-9-9-9-24)	1.8	*	*	*
ELPIDA	EBJ10UE8BAW0-DJ-E	1024MB	SS	ELPIDA	J1108BAG-DJ-E	9(1333-9-9-9-24)		*	*	*
ELPIDA	EBJ21UE8BAW0-DJ-E	2048MB	DS	ELPIDA	J1108BAG-DJ-E	9(1333-9-9-9-24)		*	*	*
G.SKILL	F3-10600CL7D-2GBPI	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1337-7-7-7-18)	1.65	*	*	*
G.SKILL	F3-10600CL8D-2GBHK	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1337-8-8-8-22)	1.65	*	*	*
G.SKILL	F3-10666CL7T-6GBPK(XMP)	2048MB	DS	N/A	Heat-Sink Package	7-7-7-18(1333-7-7-7-18)	1.5-1.6	*	*	*
G.SKILL	F3-10666CL8D-4GBHK(XMP)	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	8-8-8-21(1333-7-7-7-20)	1.5-1.6	*	*	*
G.SKILL	F3-10666CL9T-6GBNQ	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.5	*	*	*
GEIL	GV34GB1333C7DC	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-24(1333-8-8-8-28)	1.5	*	*	*
Hynix	HMT112U6BFR8C-H9	1024MB	SS	Hynix	H5TQ1G83BFR	9(1333-9-9-9-24)		*	*	*
Hynix	HMT125U6BFR8C-H9	2048MB	DS	Hynix	H5TQ1G83BFR	9(1333-9-9-9-24)		*	*	*
Hynix	HMT125U6BFR8C-H9	2048MB	DS	Hynix	H5TQ1G83BFRH9C	9(1333-9-9-9-24)		*	*	*
KINGMAX	FLFD45F-B8EE9	1024MB	SS	ELPIDA	J1108BASE-DJ-E	(1333-9-9-9-24)		*	*	*
KINGSTON	KVR1333D3N9/1G	1024MB	SS	ELPIDA	J1108BAG-DJ-E	9(1066-8-7-7-20)	1.5	*	*	*
KINGSTON	KVR1333D3N9/2G	2048MB	DS	ELPIDA	J1108BAG-DJ-E	1333-9-9-9-24	1.5	*	*	*
KINGSTON	KVR1333D3N9/2G	2048MB	DS	ELPIDA	J1108BAG-DJ-E	9(1066-8-7-7-20)	1.5	*	*	*
MICRON	MT8JTF12864AY-1G4BYES	1024MB	SS	MICRON	Z9HWR	(1333-9-9-9-24)		*	*	*
MICRON	MT8JTF12864AZ-1G4F1	1024MB	SS	MICRON	9FF22 D9KPT	9(1066-8-8-8-20)		*	*	*
MICRON	MT8JTF12864AZ-1G4F1	1024MB	SS	MICRON	D9KPT	9(1333-9-9-9-24)		*	*	*
MICRON	MT9JSF12872AZ-1G4F1	1024MB	SS	MICRON	D9KPT(ECC)	9(1333-9-9-9-24)		*	*	*
MICRON	MT16JF25664AZ-1G4F1	2048MB	DS	MICRON	D9KPT	9(1333-9-9-9-24)		*	*	*
MICRON	MT16JTF25664AZ-1G4F1	2048MB	DS	MICRON	9FF22 D9KPT	9(1066-8-8-8-20)		*	*	*
MICRON	MT18JSF25672AZ-1G4F1	2048MB	DS	MICRON	D9KPT(ECC)	9(1333-9-9-9-24)		*	*	*
OCZ	OCZ3RPX1333EB2GK	1024MB	SS	N/A	Heat-Sink Package	(1066-6-5-5-20)		*	*	*
OCZ	OCZ3G1333LV3GK	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65	*	*	*
OCZ	OCZ3P1333LV3GK	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	7-7-7(1066-7-7-7-16)	1.65	*	*	*
OCZ	OCZ3P13332GK	1024MB	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)		*	*	*
OCZ	OCZ3P13334GK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7(1333-7-7-7-20)	1.8	*	*	*
OCZ	OCZ3G1333LV8GK	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65	*	*	*
OCZ	OCZ3P1333LV8GK	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7(1066-7-7-7-20)	1.65	*	*	*
OCZ	OCZX1333LV8GK(XMP)	6144MB(Kit of 3)	DS	NA	Heat-Sink Package	8-8-8(1066-7-7-7-16)	1.6	*	*	*
SAMSUNG	M378B2873DZ1-CH9	1024MB	SS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		*	*	*
SAMSUNG	M378B2873EH1-CH9	1024MB	SS	SAMSUNG	K4B1G0846E	1066-8-7-7-20		*	*	*
SAMSUNG	M391B2873DZ1-CH9	1024MB	SS	SAMSUNG	K4B1G0846D(ECC)	9(1333-9-9-9-24)		*	*	*
SAMSUNG	M378B5673DZ1-CH9	2048MB	DS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		*	*	*
SAMSUNG	M378B5673EH1-CH9	2048MB	DS	SAMSUNG	K4B1G0846E	1066-8-7-7-20		*	*	*
SAMSUNG	M391B5673DZ1-CH9	2048MB	DS	SAMSUNG	K4B1G0846D(ECC)	9(1333-9-9-9-24)		*	*	*
Super Talent	W1333UX2GB(XMP)	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8(1333-8-8-8-24)	1.8	*	*	*
Transcend	TS128MLK64V3U	1024MB	SS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		*	*	*
Transcend	TS256MLK64V3U	2048MB	DS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		*	*	*
Asint	SLY3128M8-EDJ	1024MB	SS	Asint	DDRIII1208-DJ	(9-9-9-24)		*	*	*
Asint	SLY3128M8-EDJE	1024MB	SS	ELPIDA	J1108BASE-DJ-E	1066-8-8-8-20		*	*	*
Asint	SLZ3128M8-EDJ	2048MB	DS	Asint	DDRIII1208-DJ	(9-9-9-24)		*	*	*
Asint	SLZ3128M8-EDJE	2048MB	DS	ELPIDA	J1108BASE-DJ-E	1066-8-8-8-20		*	*	*
ASUS	N/A	1024MB	DS	N/A	Heat-Sink Package	(1333-9-9-9-24)		*	*	*
BUFFALO	FSX1333D3G-1G	1024MB	SS	N/A	Heat-Sink Package	(1066-7-7-7-20)		*	*	*
BUFFALO	FSH1333D3G-T3G(XMP)	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	7-7-7-20(1066-8-7-7-20)		*	*	*
BUFFALO	FSX1333D3G-2G	2048MB	DS	N/A	Heat-Sink Package	(1066-7-7-7-20)		*	*	*
Patriot	PDC32G1333LLK	1024MB	SS	PATRIOT	Heat-Sink Package	7(1337-7-7-7-20)	1.7	*	*	*
Patriot	PVT33G1333ELK	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65	*	*	*
Patriot	PVS34G1333ELK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.5	*	*	*
Patriot	PVS34G1333LLK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-20(1066-7-7-7-20)	1.7	*	*	*
Patriot	PVT36G1333ELK	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65	*	*	*
Silicon Power	SP001GBLTU133S02	1024MB	SS	S-POWER	I0YT3E0	9(1333-9-9-9-24)		*	*	*
Silicon Power	SP002GBLTU133S02	2048MB	DS	S-POWER	I0YT3E0	9(1333-9-9-9-24)		*	*	*

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1600MHz capability for CPU at 2.66GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
A-DATA	AD31600E001GMU	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8-24(1333-9-9-9-24)	1.65-1.85	*	*	*
A-DATA	AD31600F002GMU(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)	1.75-1.85	*	*	*
CORSAIR	TR3X3G1600C8D(XMP)Ver2.1	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8-24(1601-8-8-8-24)	1.65	*	*	*
CORSAIR	TR3X3G1600C8D	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8-24(1600-8-8-8-24)	1.65	*	*	*
CORSAIR	TR3X3G1600C9(XMP)Ver1.1	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1601-9-9-9-24)	1.65	*	*	*
CORSAIR	BoxPN:TW3X4G1600C9DHXNV(CM3X2G1600C9DHXNV)Ver4.1	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.80	*	*	*
CORSAIR	TR3X6G1600C8D(XMP)Ver2.1	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-24(1601-8-8-8-24)	1.65	*	*	*
CORSAIR	TR3X6G1600C8D	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-24(1600-8-8-8-24)	1.65	*	*	*
CORSAIR	TR3X6G1600C9(XMP)Ver2.1	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.65	*	*	*
Crucial	BL12864BA1608.8SFB(XMP)	1024MB	SS	N/A	Heat-Sink Package	(1601-8-8-8-24)	1.8	*	*	*
G.SKILL	F3-12800CL9D-2GBNQ	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.6	*	*	*
G.SKILL	F3-12800CL8T-8GBHK(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-21(1333-8-8-8-21)	1.6-1.65	*	*	*
G.SKILL	F3-12800CL8T-8GBPI(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-21(1066-8-8-8-20)	1.6-1.65	*	*	*
G.SKILL	F3-12800CL9T-8GBNQ	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1601-9-9-9-24)	1.5-1.6	*	*	*
GEIL	GV34GB1600C8DC	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	8-8-8-28(1600-8-8-8-28)	1.6	*	*	*
KINGMAX	FLGD45F-B8KG9-NAES	1024MB	SS	KINGMAX	KFB8FNGXF-ANX-12A	9(1600-9-8-9-28)	1.5	*	*	*
KINGMAX	FLGE85F-B8KG9-NEES	2048MB	DS	KINGMAX	KFB8FNGXF-ANX-12A	9(1600-9-8-9-28)	1.5	*	*	*
KINGSTON	KHX12800D3LLK3/3GX(XMP)	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	1600-8-8-8-20	1.65	*	*	*
KINGSTON	KHX12800D3K2/4G	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	9(1333-9-9-9-24)	1.9	*	*	*
KINGSTON	KHX12800D3LLK3/6GX(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	(1066-8-8-8-20)	1.65	*	*	*
OCZ	OCZ3P1600EB1G	1024MB	SS	N/A	Heat-Sink Package	7-6-8-24(1333-7-7-7-20)		*	*	*
OCZ	OCZ3G1600LV3GK	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-20)	1.65	*	*	*
OCZ	OCZ3P1600LV3GK	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	7-7-7(1066-7-7-7-20)	1.65	*	*	*
OCZ	OCZ3P16004GK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7(1333-7-7-7-20)	1.9	*	*	*
OCZ	OCZ3P1600EB4GK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-6(1333-7-7-7-20)	1.8	*	*	*
OCZ	OCZ3G1600LV6GK	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-16)	1.65	*	*	*
OCZ	OCZ3X1600LV6GK(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-16)	1.65	*	*	*
Cell Shock	CS322271	2048MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-14(1066-7-7-7-20)	1.7-1.9	*	*	*
Mushkin	998657	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-20		*	*	*
Mushkin	998659(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.5-1.6	*	*	*
Patriot	PVT33G1600ELK	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65	*	*	*
Patriot	PVS34G1600ELK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.8	*	*	*
Patriot	PVS34G1600LLK(XMP)	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-20(1066-7-7-7-20)	1.9	*	*	*
Patriot	PVS34G1600LLKN	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-20(1066-7-7-7-20)	2.0	*	*	*
Patriot	PVT36G1600ELK	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65	*	*	*
Patriot	PVT36G1600ELK	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1600-7-7-7-20)	1.65	*	*	*
PQI	MFADR401PA0102(XMP)	2048MB	DS	SAMSUNG	K4B1G08460	1066-8-8-8-20		*	*	*

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1600MHz capability for CPU at 2.8 and 2.93GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
A-DATA	AD31600E001GMU	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8-24(1333-9-9-9-24)	1.65-1.85	*	*	*
A-DATA	AD31600F002GMU(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)	1.75-1.85	*	*	*
CORSAIR	TR3X3G1600C8D(XMP)Ver2.1	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8-24(1601-8-8-8-24)	1.65	*	*	*
CORSAIR	TR3X3G1600C8D	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8-24(1600-8-8-8-24)	1.65	*	*	*
CORSAIR	TR3X3G1600C9(XMP)Ver1.1	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1601-9-9-9-24)	1.65	*	*	*
CORSAIR	BoxP/N:TW3X4G1600C9DHXNV(CM3X2G1600C9DHXNV)Ver4.1	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.80	*	*	*
CORSAIR	TR3X6G1600C8D(XMP)Ver2.1	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-24(1601-8-8-8-24)	1.65	*	*	*
CORSAIR	TR3X6G1600C8D	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-24(1600-8-8-8-24)	1.65	*	*	*
CORSAIR	TR3X6G1600C9(XMP)Ver2.1	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.65	*	*	*
Crucial	BL12864BA1608.8SFB(XMP)	1024MB	SS	N/A	Heat-Sink Package	(1601-8-8-8-24)	1.8	*	*	*
G.SKILL	F3-12800CL9D-2GBNQ	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.6	*	*	*
G.SKILL	F3-12800CL8T-6GBHK(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-21(1333-8-8-8-21)	1.6-1.65	*	*	*
G.SKILL	F3-12800CL8T-8GBPI(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-21(1066-8-8-8-20)	1.6-1.65	*	*	*
G.SKILL	F3-12800CL9T-6GBNQ	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1601-9-9-9-24)	1.5-1.6	*	*	*
GEIL	GV34GB1600C8DC	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	8-8-8-28(1600-8-8-8-28)	1.6	*	*	*
KINGMAX	FLGD45F-B8KG9-NAES	1024MB	SS	KINGMAX	KFB8FNGXF-ANX-12A	9(1600-9-8-9-28)	1.5	*	*	*
KINGMAX	FLGE85F-B8KG9-NEES	2048MB	DS	KINGMAX	KFB8FNGXF-ANX-12A	9(1600-9-8-9-28)	1.5	*	*	*
KINGSTON	KHX12800D3LLK3/3GX(XMP)	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	1600-8-8-8-20	1.65	*	*	*
KINGSTON	KHX12800D3K3/12GX(XMP)	12288MB(Kit of 3)	DS	N/A	Heat-Sink Package	9(1066-9-9-9-24)		*	*	*
KINGSTON	KHX12800D3K2/4G	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	9(1333-9-9-9-24)	1.9	*	*	*
KINGSTON	KHX12800D3LLK3/6GX(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	(1066-8-8-8-20)	1.65	*	*	*
OCZ	OCZ3P1600EB1G	1024MB	SS	N/A	Heat-Sink Package	7-6-6-24(1333-7-7-7-20)		*	*	*
OCZ	OCZ3G1600LV3GK	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-20)	1.65	*	*	*
OCZ	OCZ3P1600LV3GK	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	7-7-7(1066-7-7-7-20)	1.65	*	*	*
OCZ	OCZ3P16004GK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7(1333-7-7-7-20)	1.9	*	*	*
OCZ	OCZ3P1600EB4GK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-6(1333-7-7-7-20)	1.8	*	*	*
OCZ	OCZ3X16004GK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-20	1.9	*	*	*
OCZ	OCZ3G1600LV6GK	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-16)	1.65	*	*	*
OCZ	OCZ3X1600LV6GK(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8(1600-8-8-8-24)	1.65	*	*	*
OCZ	OCZ3X1600LV6GK(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-16)	1.65	*	*	*
Super Talent	WB180U/X6GB(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	1333-8-8-8-24		*	*	*
Cell Shock	CS322271	2048MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-14(1066-7-7-7-20)	1.7-1.9	*	*	*
Mushkin	996657	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-20		*	*	*
Mushkin	998659(XMP)	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.5-1.6	*	*	*
Patriot	PVT33G1600ELK	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65	*	*	*
Patriot	PVS34G1600ELK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.8	*	*	*
Patriot	PVS34G1600LLK(XMP)	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-20(1066-7-7-7-20)	1.9	*	*	*
Patriot	PVS34G1600LLKN	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-20(1066-7-7-7-20)	2.0	*	*	*
Patriot	PVT36G1600ELK	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65	*	*	*
Patriot	PVT36G1600ELK	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1600-7-7-7-20)	1.65	*	*	*
PQI	MFADR401PA0102(XMP)	2048MB	DS	SAMSUNG	K4B1G08460	1066-8-8-8-20		*	*	*

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1625MHz capability for CPU at 2.66GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
KINGSTON	KHX13000D3LLK2/2GN(EPP)	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•	•
KINGSTON	KHX13000D3LLK2/2GX(XMP)	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•	•
KINGSTON	KHX13000D3LLK2/2GXN	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•	•

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1625MHz capability for CPU at 2.8 and 2.93GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Lable(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
KINGSTON	KHX13000D3LLK2/2GN(EPP)	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•	•
KINGSTON	KHX13000D3LLK2/2GX(XMP)	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•	•
KINGSTON	KHX13000D3LLK2/2GXN	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•	•

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1800MHz capability for CPU at 2.66GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
Apacer	78.0AGCD-CDZ(XMP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1800-8-8-8-24)	1.8	•	•	
CORSAIR	BoxP/N:TW3X4G1800C8DF (CM3X2G1800C8D)Ver4.1	4GB(Kit of 2)	DS	N/A	Heat-Sink Package	8-8-8-24	1.80	•	•	
KINGSTON	KHX14400D3/1G	1GB	SS	N/A	Heat-Sink Package		1.9	•	•	
KINGSTON	KHX14400D3K2/2GN(EPP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•	•
KINGSTON	KHX14400D3K3/3GX(XMP)	3GB(Kit of 3)	SS	N/A	Heat-Sink Package	1800-9-9-9-27	1.65	•	•	
OCZ	OCZ3P18002GK	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8				•
OCZ	OCZ3P18004GK	4GB(Kit of 2)	DS	N/A	Heat-Sink Package	8	1.9	•	•	
Transcend	TX1800KLU-2GK(XMP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8		•	•	•
Patriot	PVS32G1800LLKN(EPP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-20(1066-7-7-7-20)	1.9	•	•	

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1800MHz capability for CPU at 2.8 and 2.93GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
Apacer	78.0AGCD-CDZ(XMP)	2048MB(KIT of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1800-8-8-8-24)	1.8	•	•	
CORSAIR	BoxP/N:TW3X4G1800C8DF (CM3X2G1800C8D)Ver4.1	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	8-8-8-24	1.80	•	•	
KINGSTON	KHX14400D3/1G	1024MB	SS	N/A	Heat-Sink Package		1.9	•	•	
KINGSTON	KHX14400D3K2/2GN(EPP)	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•	
KINGSTON	KHX14400D3K3/3GX(XMP)	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	1800-9-9-9-27	1.65	•	•	
OCZ	OCZ3P18002GK	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8		•	•	
OCZ	OCZ3P18004GK	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	8	1.9	•	•	
Transcend	TX1800KLU-2GK(XMP)	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8		•	•	
Patriot	PVS32G1800LLKN(EPP)	2048MB(KIT of 2)	SS	N/A	Heat-Sink Package	8-8-8-20(1066-7-7-7-20)	1.9	•	•	

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1866MHz capability for CPU at 2.66GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
Apacer	78.0AGCQ.CBZ(XMP)	3GB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-27(1066-8-8-8-20)		.	.	.
Crucial	BL12864BE2009.8SFB3(EPP)	1GB	SS	N/A	Heat-Sink Package	9-9-9-28(1333-9-9-9-24)	2	.	.	.
G.SKILL	F3-16000CL7T-8GBPS(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	7-8-7-20(1066-8-8-8-20)	1.65	.	.	.
G.SKILL	F3-16000CL9T-8GBPS(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-8-8-8-20)	1.65	.	.	.
KINGSTON	KHX16000D3K2/2GN(EPP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package		2.0	.	.	.
KINGSTON	KHX16000D3K3/3GX(XMP)	3GB(Kit of 3)	SS	N/A	Heat-Sink Package	9(1333-9-9-9-24)	1.65	.	.	.
KINGSTON	KHX16000D3ULT1K3/6GX(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	8(1066-8-8-8-20)	1.65	.	.	.
KINGSTON	KHX16000D3T1K3/6GX(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	9(1066-8-8-8-20)	1.65	.	.	.
OCZ	OCZ3FXT20002GK	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8	1.9	.	.	.
OCZ	OCZ3P20002GK(EPP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	9	1.9	.	.	.
OCZ	OCZ3P2000EB2GK	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	9-8-8(1066-8-7-7-20)	1.8	.	.	.
Gingje	9CAASS37AZZ01D1	2GB	DS	N/A	Heat-Sink Package	9-9-9-24		.	.	.

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-1866MHz capability for CPU at 2.8 and 2.93GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
CORSAIR	TR3X3G1866C9D(XMP)	3GB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1866-9-9-9-24)	1.65	.	.	.
CORSAIR	TR3X6G1866C9D	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1866-9-9-9-24)	1.65	.	.	.
KINGSTON	KHX14900D3K3/3GX(XMP)	3GB	SS	N/A	Heat-Sink Package	9(1333-9-9-9-24)	1.65	.	.	.
OCZ	OCZ3RPR1866C9LV3GK	3GB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65	.	.	.
OCZ	OCZ3RPR1866C9LV6GK	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65	.	.	.
Super Talent	W1866UX2GB(XMP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1333-9-9-9-24)		.	.	.
Patriot	PVS32G1866LLK(XMP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1066-7-7-7-20)	1.9	.	.	.
Patriot	PVS32G1866LLK(XMP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1866-8-8-8-24)	1.9	.	.	.

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-2000MHz capability for CPU at 2.66GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
Apacer	78.0AGCQ.CBZ(XMP)	3GB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-27(1066-8-8-8-20)		.	.	.
Crucial	BL12864BE2009.8SFB3(EPP)	1GB	SS	N/A	Heat-Sink Package	9-9-9-28(1333-9-9-9-24)	2	.	.	.
G.SKILL	F3-16000CL7T-8GBPS(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	7-8-7-20(1066-8-8-8-20)	1.65	.	.	.
G.SKILL	F3-16000CL9T-8GBPS(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-8-8-8-20)	1.65	.	.	.
KINGSTON	KHX16000D3K2/2GN(EPP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package		2.0	.	.	.
KINGSTON	KHX16000D3K3/3GX(XMP)	3GB(Kit of 3)	SS	N/A	Heat-Sink Package	9(1333-9-9-9-24)	1.65	.	.	.
KINGSTON	KHX16000D3ULT1K3/6GX(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	8(1066-8-8-8-20)	1.65	.	.	.
KINGSTON	KHX16000D3T1K3/6GX(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	9(1066-8-8-8-20)	1.65	.	.	.
OCZ	OCZ3FXT20002GK	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8	1.9	.	.	.
OCZ	OCZ3P20002GK(EPP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	9	1.9	.	.	.
OCZ	OCZ3P2000EB2GK	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	9-8-8(1066-8-7-7-20)	1.8	.	.	.
Gingje	9CAASS37AZZ01D1	2GB	DS	N/A	Heat-Sink Package	9-9-9-24		.	.	.

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-2000MHz capability for CPU at 2.8 and 2.93GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
Apacer	78.0AGCQ.CBZ(XMP)	3GB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-27(1066-8-8-8-20)		.	.	.
Crucial	BL12864BE2009.8SFB3(EPP)	1GB	SS	N/A	Heat-Sink Package	9-9-9-28(1333-9-9-9-24)	2	.	.	.
G.SKILL	F3-16000CL7T-6GBPS(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	7-8-7-20(1066-8-8-8-20)	1.65	.	.	.
G.SKILL	F3-16000CL9T-6GBPS(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-8-8-8-20)	1.65	.	.	.
KINGSTON	KHX16000D3K2/2GN(EPP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package		2.0	.	.	.
KINGSTON	KHX16000D3K3/3GX(XMP)	3GB(Kit of 3)	SS	N/A	Heat-Sink Package	9(1333-9-9-9-24)	1.65	.	.	.
KINGSTON	KHX16000D3ULT1K3/6GX(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	8(1066-8-8-8-20)	1.65	.	.	.
KINGSTON	KHX16000D3T1K3/6GX(XMP)	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	9(1066-8-8-8-20)	1.65	.	.	.
OCZ	OCZ3FXT20002GK	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	8	1.9	.	.	.
OCZ	OCZ3P20002GK(EPP)	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	9	1.9	.	.	.
OCZ	OCZ3P2000EB2GK	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	9-8-8(1066-8-7-7-20)	1.8	.	.	.
Gingie	9CAASS37AZZ01D1	2GB	DS	N/A	Heat-Sink Package	9-9-9-24		.	.	.
Patriot	PVS32G2000LLKN	2GB(Kit of 2)	SS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	2	.	.	.

P7P55D Motherboard Qualified Vendors Lists (QVL) DDR3-2133MHz capability for CPU at 2.8 and 2.93GHz

Vendor	Part No.	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)		
								A*	B*	C*
G.SKILL	F3-17066CL9T-6GB-T	6GB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-8-7-7-20)	1.65	.	.	.



Side(s): SS - Single-sided DS - Double-sided

DIMM support:

- **A***: Supports one (1) module inserted into slot A1 or B1 as Single-channel memory configuration.
- **B***: Supports two (2) modules inserted into the blue slots (A1 and B1) as one pair of Dual-channel memory configuration.
- **C***: Supports four (4) modules inserted into both the blue and the black slots as two pairs of Dual-channel memory configuration.



- ASUS exclusively provides hyper DIMM support function.
- Hyper DIMM support is subject to the physical characteristics of individual CPUs.
- According to Intel spec definition, DDR3-1600 is supported for one DIMM per channel only. ASUS exclusively provides two DDR3-1600 DIMM support for each memory channel.
- According to Intel CPU spec, CPUs with a core frequency of 2.66G support the maximum DIMM frequency of up to DDR3-1333. To use DIMMs of a higher frequency with a 2.66G CPU, enable the **DRAM O.C. Profile** feature in BIOS. Refer to section **3.5.3 Ai Overclock Tuner** for details.
- Visit the ASUS website for the latest QVL.